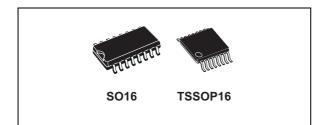


M74HC4060

14-stage binary counter/oscillator

Datasheet - production data



Features

- High speed: f_{max} = 65 MHz (typ.) at V_{CC} = 6 V
- Low power dissipation: I_{CC} = 4 A (max.) at T_A = 25 °C
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (min.)
- Symmetrical output impedance: |I_{OH}| = I_{OL} = 4 mA (min.)
- Balanced propagation delays: $T_{PLH} \cong T_{PHL}$
- Wide operating voltage range:
 V_{CC} (opr.) = 2 V to 6 V
- Pin and function compatible with 74 series 4060
- ESD performance
 - HBM: 2 kV
 - MM: 200 V
 - CDM: 1 kV

Applications

- Automotive
- Industrial
- Computer
- Consumer

Description

The M74HC4060 device is a high speed CMOS 14-stage binary counter/oscillator fabricated with silicon gate C^2MOS technology.

The oscillator configuration allows design of either RC or crystal oscillator circuits. A high level on the CLEAR accomplishes the reset function, i.e. all counter outputs are made low and the oscillator is disabled.

A negative transition on the clock input increments the counter. Ten kinds of divided output are provided; 4 to 10 and 12 to 14 stage inclusive. The maximum division available at Q12 is 1/16384 of the oscillator frequency.

The $\overline{\varnothing}$ I input and the CLEAR input are equipped with protection circuits against static discharge and transient excess voltage.

Order code	Temperature range	Package	Packing	Marking
M74HC4060RM13TR	-55 °C to +125 °C	SO16		74HC4060
M74HC4060YRM13TR ⁽¹⁾	-40 °C to +125 °C	SO16 (automotive version)	Tape and reel	74HC4060Y
M74HC4060TTR	-55 °C to +125 °C	TSSOP16	Tape and Teel	HC4060
M74HC4060YTTR ⁽¹⁾	-40 °C to +125 °C	TSSOP16 (automotive version)		HC4060Y

Table 1. Device summary

1. Qualification and characterization according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 and Q002.

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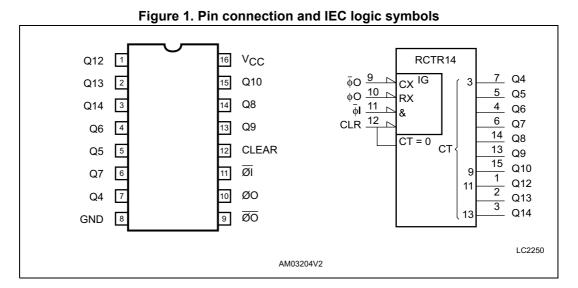
This is information on a product in full production.

Contents

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3	Electrical characteristics5
4	Package information
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	4.2 TSSOP16 package information 14
5	Ordering information15
6	Revision history



1 Pin description



T . I. I .	~	D !	
lable	Ζ.	PIN	description

Pin no	Symbol	Name and function
1, 2, 3	Q12 to Q14	Counter outputs
7, 5, 4, 6, 14, 13, 15	Q4 to Q10	
9	ØŌ	External capacitor connection
10	ØO	External resistor connection
11	Ø	Clock input / oscillator pin
12	CLEAR	Master reset
8	GND	Ground (0 V)
16	V _{CC}	Positive supply voltage



2 Functional description

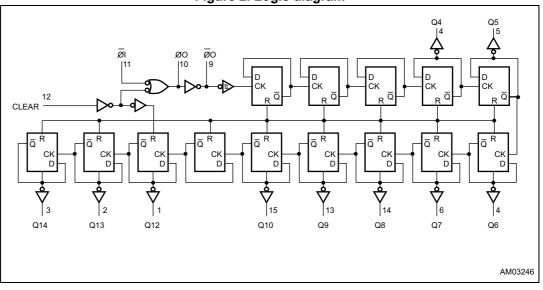


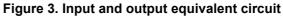
Figure 2. Logic diagram

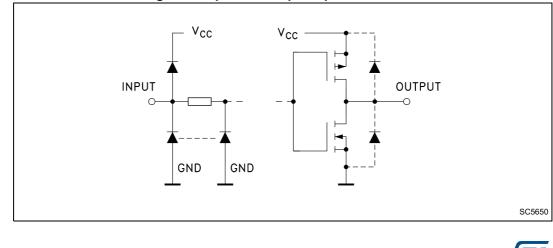
1. This logic diagram has not be used to estimate propagation delays.

Ø	CLEAR	Function
X ⁽¹⁾	Н	Counter is reset to zero state \oslash O output goes to high level $\overline{\oslash}\overline{O}$ output goes to low level
	L	Count up one step
	L	No change

Table 3. Truth table

1. X: don't care.





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3 Electrical characteristics

Symbol	Parameter	Value	Unit	
V _{CC}	Supply voltage	-0.5 to +7		
VI	V _I DC Input voltage		V	
V _O	DC output voltage	-0.5 to V _{CC} + 0.5		
I _{IK}	DC input diode current	20		
I _{OK}	DC output diode current	20	mA	
Ι _Ο	DC output current	25	ma	
$\rm I_{CC}$ or $\rm I_{GND}$	DC VCC or ground current	50		
PD	Power dissipation	500 ⁽²⁾	mW	
T _{stg}	Storage temperature	-65 to +150	°C	
ΤL	Lead temperature (10 sec.)	300	C	

Table 4. Absolute maximum ratings⁽¹⁾

1. Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

2. 500 mW at 65 °C; derate to 300 mW by 10 mW/ C from 65 °C to 85 °C.

Symbol	Parameter		Value	Unit				
V _C	Supply voltage		2 to 6					
VI	Input voltage		0 to V	V				
V _O	Output voltage		0 to V _{CC}					
T _{op}	Operating temperature		-55 to 125	°C				
		V _{CC} = 2.0 V	0 to 1000					
t _r , t _f	Input rise and fall time	V _{CC} = 4.5 V	0 to 500	ns				
		V _{CC} = 6.0 V	0 to 400					

Table 5. Recommended operating conditions



		Test condition			Value						
Symbol	Parameter	V _{CC}		T _A = 25°C			-40 to	85 °C	-55 to 125 °C		Unit
		(V)		Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
		2.0		1.5			1.5		1.5		
V_{IH}	High level input voltage	4.5		3.15			3.15		3.15		V
		6.0		4.2			4.2		4.2		
		2.0				0.5		0.5		0.5	
V _{IL}	Low level input voltage	4.5				1.35		1.35		1.35	V
		6.0				1.8		1.8		1.8	
		2.0	I _O = -20 A	1.9	2.0		1.9		1.9		
		4.5	I _O = -20 A	4.4	4.5		4.4		4.4		V
V _{OH}	High level output voltage (Q output)	6.0	I _O = -20 A	5.9	6.0		5.9		5.9		
		4.5	I _O = -4.0 mA	4.18	4.31		4.13		4.10		
		6.0	I _O = -5.2 mA	5.68	5.8		5.63		5.60		
		2.0	I _O = 20 A		0.0	0.1		0.1		0.1	v
		4.5	I _O = 20 A		0.0	0.1		0.1		0.1	
V _{OL}	Low level output voltage (Q output)	6.0	I _O = 20 A		0.0	0.1		0.1		0.1	
	(4.5	l _O = 4.0 mA		0.17	0.26		0.33		0.40	
		6.0	l _O = 5.2 mA		0.18	0.26		0.33		0.40	
		2.0	I _O =-20 A	1.8	2.0		1.8		1.8	2.0	
V _{OH}	High level output voltage (ØO, ØO output)	4.5	I _O = -20 A	4.4	4.5		4.0		4.0		V
		6.0	I _O = -20 A	5.5	5.9		5.5		5.5		
		2.0	I _O = -20 A		0.0	0.2		0.2		0.2	
V _{OL}	Low level output voltage $(\emptyset O, \overline{\emptyset} \overline{O}$ output)	4.5	I _O = -20 A		0.0	0.5		0.5		0.5	V
		6.0	I _O = -20 A		0.1	0.5		0.5		0.5	
l _l	Input leakage current	6.0	$V_{I} = V_{CC}$ or GND			0.1		±1		±1	μA
I _{CC}	Quiescent supply current	6.0	$V_{I} = V_{CC}$ or GND			4		40		80	μA

Table 6. DC specifications





		Test condition	Value							
Symbol	Parameter		T _A = 25 °C			-40 to 85 °C		-55 to 125 °C		Unit
		V _{CC} (V)	Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
		2.0		30	75		95		110	
t _{TLH} t _{THL}	Output transition time	4.5		8	15		19		22	ns
		6.0		7	13		16		19	
		2.0		170	300		375		450	
t _{PLH} t _{PHL}	Propagation delay time (Øl - Q4)	4.5		41	60		75		90	ns
		6.0		30	51		64		76	
	Propagation delay	2.0		32	75		95		110	
t _{PD}	time difference (Qn - Qn+1)	4.5		7	15		19		22	ns
		6.0		5	13		16		19	
	Propagation delay time (CLEAR - Qn)	2.0		85	195		245		295	ns
t _{PHL}		4.5		23	39		49		59	
		6.0		17	33		42		50	
		2.0	6	12		5		4		
f _{MAX}	Maximum clock frequency	4.5	30	50		24		20		MHz
	lioquonoy	6.0	35	65		28		24		
		2.0		30	75		95		110	
t _{W(H)} , t _{W(L)}	Minimum pulse width $(\overline{\emptyset})$	4.5		8	15		19		22	ns
		6.0		7	13		16		19	
		2.0		30	75		95		110	
t _{W(H)}	Minimum pulse width (CLEAR)	4.5		8	15		19		22	ns
		6.0		7	13		16		19	1
		2.0		40	100		125		150	
t _{REM}	Minimum removal time	4.5		10	20		25		30	ns
		6.0		9	17		21		26	1

Table 7. AC electrical characteristics	(C _L = 50 pF, input t _r = t _f = 6 ns)



			-							
		Test condition				Value				
Symbol	Parameter	V _{CC} (V)	T _A = 25 °C		T _A = 25 °C -40 to 85 °C		-55 to	125 °C	Unit	
			Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
C _{IN}	Input capacitance	5.0	5	10		10		10		
C _{PD}	Power dissipation capacitance ⁽¹⁾	5.0		27						pF

Table 8. Capacitive characteristics

 C_{PD} is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to *Figure 4: Test circuit*). Average operating current can be obtained by the following equation. I_{CC}(opr.) = C_{PD} x V_{CC} x f_{IN} + I_{CC}.

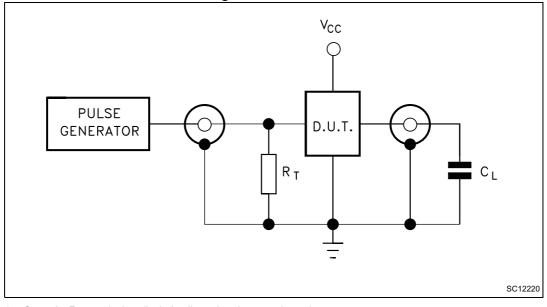
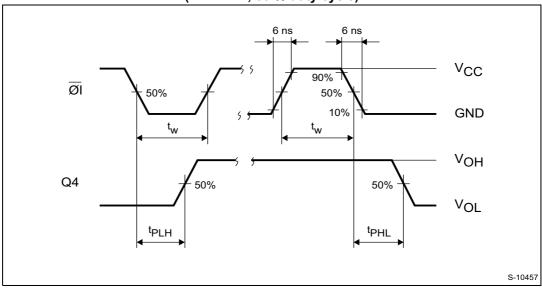


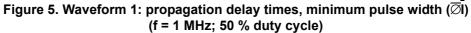
Figure 4. Test circuit

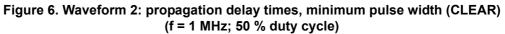
1. C_L = 50 pF or equivalent (includes jig and probe capacitance) R_T = Z_{OUT} of pulse generator (typically 50 Ω).

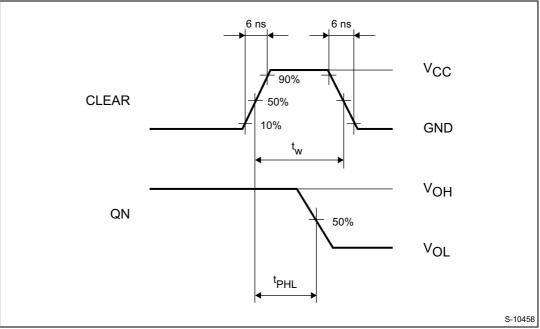


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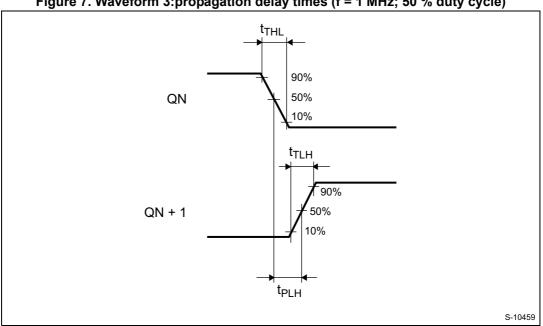
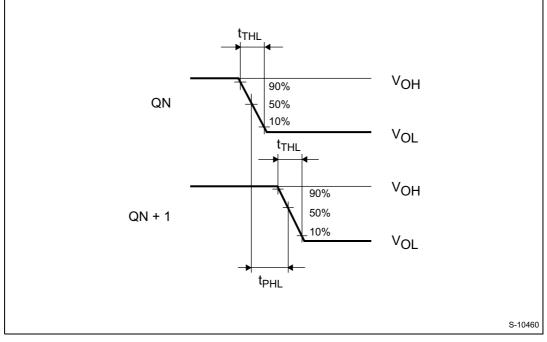


Figure 7. Waveform 3:propagation delay times (f = 1 MHz; 50 % duty cycle)







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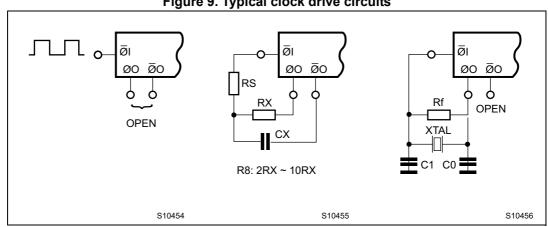


Figure 9. Typical clock drive circuits



4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK is an ST trademark.



4.1 SO16 package information

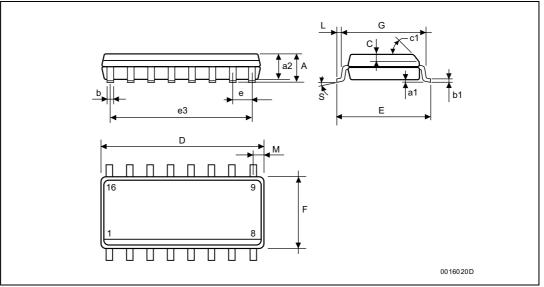


Figure 10. SO16 package outline

	Dimensions										
Symbol		mm		inch							
	Min.	Тур.	Max.	Min.	Тур.	Max.					
А			1.75			0.068					
a1	0.1		0.2	0.003		0.007					
a2			1.65			0.064					
b	0.35		0.46	0.013		0.018					
b1	0.19		0.25	0.007		0.010					
С		0.5			0.019						
c1			45°	(typ.)							
D	9.8		10	0.385		0.393					
E	5.8		6.2	0.228		0.244					
е		1.27			0.050						
e3		8.89			0.350						
F	3.8		4.0	0.149		0.157					
G	4.6		5.3	0.181		0.208					
L	0.5		1.27	0.019		0.050					
М			0.62			0.024					
S			8° (r	nax.)							

Table 9. SO16 package mechanical data



4.2 TSSOP16 package information

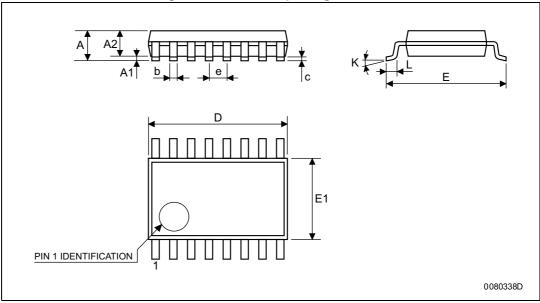


Figure 11. TSSOP16 package outline

Table 10. TSSOP16 mechanical data

	Dimensions						
Symbol	mm			inch			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А			1.2			0.047	
A1	0.05		0.15	0.002	0.004	0.006	
A2	0.8	1	1.05	0.031	0.039	0.041	
b	0.19		0.30	0.007		0.012	
С	0.09		0.20	0.004		0.0089	
D	4.9	5	5.1	0.193	0.197	0.201	
E	6.2	6.4	6.6	0.244	0.252	0.260	
E1	4.3	4.4	4.48	0.169	0.173	0.176	
е		0.65			0.0256		
К	0°		8°	0°		8°	
L	0.45	0.60	0.75	0.018	0.024	0.030	



5 Ordering information

Order code	Temperature Package range		Packing	Marking
M74HC4060RM13TR	-55 °C to +125 °C	SO16		74HC4060
M74HC4060YRM13TR ⁽¹⁾	-40 °C to +125 °C	SO16 (automotive version)	Tape and reel	74HC4060Y
M74HC4060TTR	-55 °C to +125 °C	TSSOP16		HC4060
M74HC4060YTTR ⁽¹⁾	-40 °C to +125 °C	TSSOP16 (automotive version)		HC4060Y

Table 11. Device summary

1. Qualification and characterization according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 and Q002.



6 Revision history

Date	Revision	Changes
1-Feb-2008	1	Initial release.
15-May-2013	2	 Added Applications on page 1. Corrected Description (replaced "The maximum division available at Q12 is 1/16384 f oscillator." by "The maximum division available at Q12 is 1/16384 of the oscillator frequency."). Updated Table 1 (added order codes, temperature range, updated package, added marking). Moved Figure 1 to page 3. Redrawn Figure 1, Figure 2, Figure 5 to Figure 9. Added Contents. Added titles to Section 1: Pin description to Section 6: Revision history. Added numbers to Table 1 to Table 12 and Figure 1 to Figure 11. Updated Section 4: Package information (added ECOPACK text, reversed order of Figure 10 to Figure 11 and Table 9 to Table 10). Minor corrections throughout document.
10-Jan-2014	3	Removed PDIP16 package Added ESD data to <i>Features</i> <i>Table 1: Device summary</i> : added "Packing" and updated footnote <i>1</i> . Added <i>Section 5: Ordering information</i> Updated layout

Table 12. Document revision history



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